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TOSHIBA Photocoupler GaA{As Ired & Photo-Diode Array

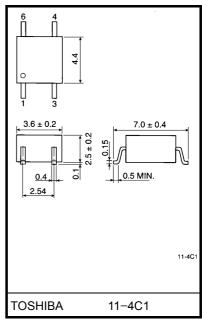
## TLP190B

Telecommunications Programmable Controllers MOS Gate Drivers MOSFET Gate Drivers

The TOSHIBA TLP190B mini-flat photocoupler is suitable for surface mount assembly.

The TLP190B consists of a GaAlAs light emitting diode optically coupled to a series connected photodiode array which is suitable for MOSFET gate drivers.

- Open voltage: 7.0V (min)
- Short current: 12.0 µA (min)
- Isolation voltage: 2500 Vrms (min)
- UL recognized: UL1577, file no. E67349



Weight: 0.09 g (typ.)

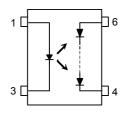
#### **Short Current**

Туре	Classification	Short Current		Marking of
Name	Classification	Short Currer           (min)         I <sub>F</sub> 20 μA         10 m           12 μA         10 m	IF	Classification
TLP190B	С20 20 µА		20	
161 1908	Standard	12 µA	TO THA	20, blank

Note: Application type name for certification test, please use standard product type name, i.e.

TLP190B(C20): TLP190B

#### Pin Configuration (top view)



1. Anode 3. Cathode 4. Cathode 6. Anode

Start of commercial production 1990/11

Unit: mm

#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	١ <sub>F</sub>	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI <sub>F</sub> / °C	-0.5	mA / °C
LED	Pulse forward current (100µs pulse 100pps)	I <sub>FP</sub>	1	A
	Reverse voltage	V <sub>R</sub>	3	V
	Junction temperature	Tj	125	°C
	Forward current	I <sub>FD</sub>	50	μA
Detector	Reverse voltage	V <sub>RD</sub>	10	V
	Junction temperature	Tj	125	°C
Storage terr	perature range	T <sub>stg</sub>	T <sub>stg</sub> –55 to 125	
Operating temperature range		T <sub>opr</sub> –40 to 85		°C
Lead soldering temperature (10 s)		T <sub>sol</sub> 260		°C
Isolation vol (AC, 1 minu	tage te, R.H. ≤ 60%) Note 1	BVS	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	١ <sub>F</sub>	_	20	25	mA
Operating temperature	T <sub>opr</sub>	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.2	1.4	1.7	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 3 V	-	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	_	30	60	pF
	Forward voltage	V <sub>FD</sub>	I <sub>FD</sub> = 10 μA	_	7	—	V
Detector	Reverse current	I <sub>RD</sub>	V <sub>RD</sub> = 10 V	-	1	_	nA
	Capacitance (anode to cathode)	C <sub>TD</sub>	V = 0, f = 1 MHz	_	_	_	pF

#### Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Open voltage	V <sub>OC</sub>	I <sub>F</sub> = 10 mA	7	8	_	V
Short current	I <sub>SC</sub>	I <sub>F</sub> = 10 mA	12	20		μA

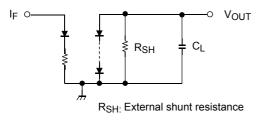
#### Isolation Characteristics (Ta = 25°C)

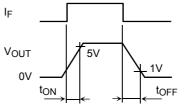
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	AC, 1 minute 2500	-	_	Vrms		
	BVS	AC, 1 second in oil	, 			
		DC, 1 minute in oil	—	5000		Vdc

#### Switching Characteristics (Ta = 25°C)

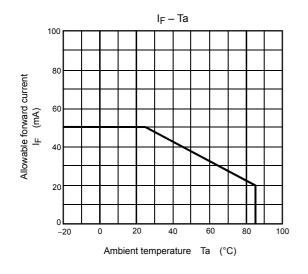
Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>	I <sub>F</sub> = 20 mA, R <sub>SH</sub> = 510 kΩ		_	0.2	-	ms
Turn-off time	tOFF	C <sub>L</sub> = 1000pF	(Fig. 1)	_	1	_	ms

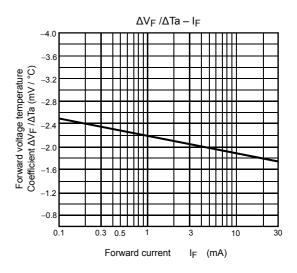
Fig. 1 Switching time test circuit

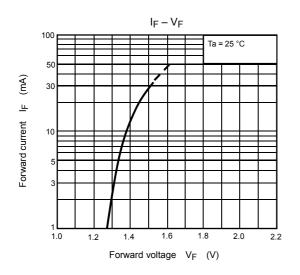


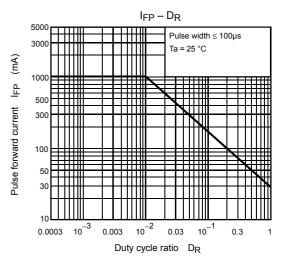


### **TOSHIBA**

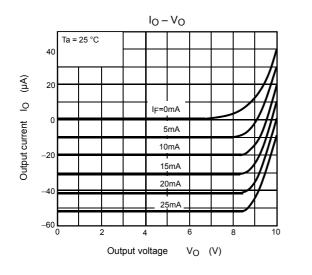


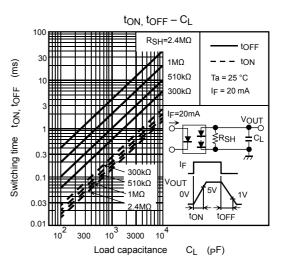


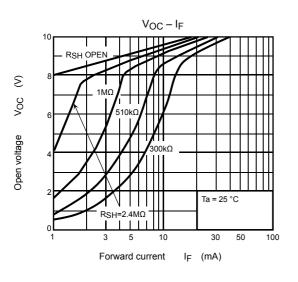


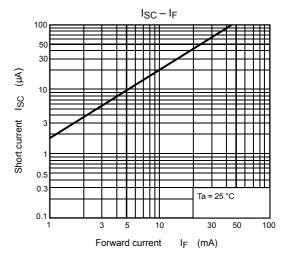


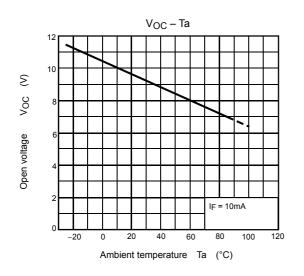
### **TOSHIBA**

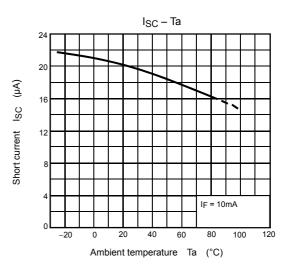












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